

# SPECIFICATION AGM 2002F-201

#### **SPECIFICATION**

CUSTOMER	:	
MODULE NO.:		AGM 2002F-201

$\mathbf{A}$	PP	R	IO	/ED	BY:
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(FOR CUSTOMER USE ONLY)

PCB VERSION:

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2017/02/22		First issue



MODLE NO:
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#### RECORDS OF REVISION

#### DOC. FIRST ISSUE

VERSIO N	DATE	REVISE D PAGE NO.	SUMM ARY
0	2017/02/		First issue
	22		

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#### 1.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) AGT have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) AGT have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, AGT have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.

### **2.General Specification**

Item	Dimension	Unit					
Number of Characters	20 characters x 2Lines	_					
Module dimension	146.0 x 43.0 x 13.7 (MAX)	mm					
View area	123.0 x 23.0	mm					
Active area	118.84 x 18.97	mm					
Dot size	0.92 x 1.10	mm					
Dot pitch	0.98 x 1.16	mm					
Character size	4.84 x 9.22	mm					
Character pitch	6.00 x 9.75	mm					
LCD type	STN Positive, Yellow Green Transflective  (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)						
Duty	1/16						
View direction	6 o'clock						
Backlight Type	LED, Yellow Green						
IC	ST7066U						

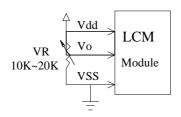
### **3.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{OP}$	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{\mathrm{ST}}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V <sub>I</sub>	$V_{SS}$	_	$V_{DD}$	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	-0.3	_	7	V
Supply Voltage For LCD	$V_{DD}$ - $V_{o}$	-0.3	_	13	V

### **4. Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20°C	_	_	5.5	V
*Note	$V_{DD}$ - $V_0$	Ta=25°C	4.4	4.5	4.6	V
		Ta=70°C	3.8	_	_	V
Input High Volt.	$V_{\mathrm{IH}}$	_	0.7 V <sub>DD</sub>	_	$V_{DD}$	V
Input Low Volt.	$V_{\rm IL}$	_	Vss	_	0.6	V
Output High Volt.	V <sub>OH</sub>	_	3.9	_	$V_{\mathrm{DD}}$	V
Output Low Volt.	$V_{\mathrm{OL}}$	_	0	_	0.4	V
Supply Current	$I_{\mathrm{DD}}$	V <sub>DD</sub> =5.0V	1.0	1.2	1.5	mA

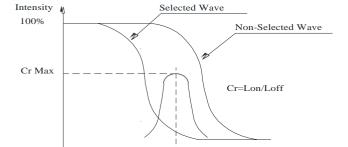
<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board



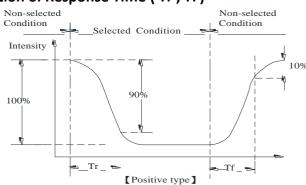
### **5.Optical Characteristics**

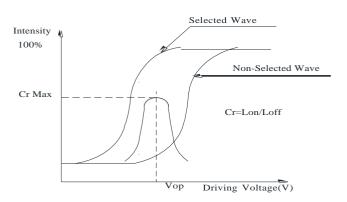
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\Psi = 180^{\circ}$
View Angle	$ θ $ $ CR \ge 2 $ $ Θ $ $ O$					
View Angle	θ	CR≧2	0	_	30	$\begin{array}{ccc} 20 & \psi = 180^{\circ} \\ 40 & \psi = 0^{\circ} \\ 30 & \psi = 90^{\circ} \\ \hline 30 & \psi = 270^{\circ} \\ \hline - & - \\ 200 & ms \\ \end{array}$
	θ	CR≧2	0	_	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	
Contrast Ratio	CR	_	_	3	_	_
Dagnanga Tima	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	$\psi = 180^{\circ}$ $\psi = 0^{\circ}$ $\psi = 90^{\circ}$ $\psi = 270^{\circ}$ $-$ $ms$

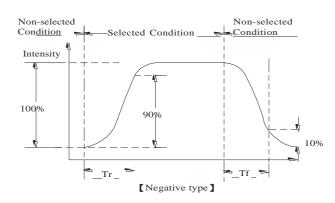
#### **Definition of Operation Voltage (Vop)**



#### Definition of Response Time (Tr, Tf)







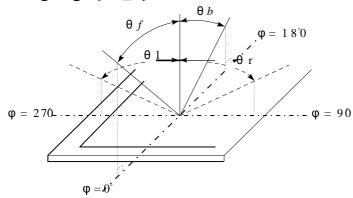
#### **Conditions:**

Operating Voltage : Vop Frame Frequency : 64 HZ

Driving Voltage(V)

Viewing Angle( $\theta$ ,  $\phi$ ):  $0^{\circ}$ ,  $0^{\circ}$ Driving Waveform: 1/N duty, 1/a bias

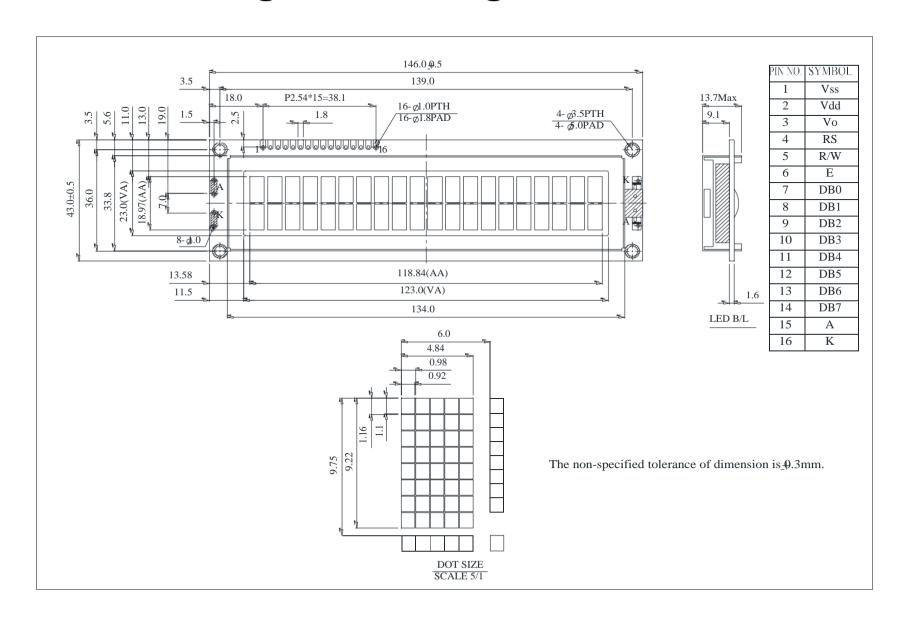
Definition of viewing angle(CR≥2)

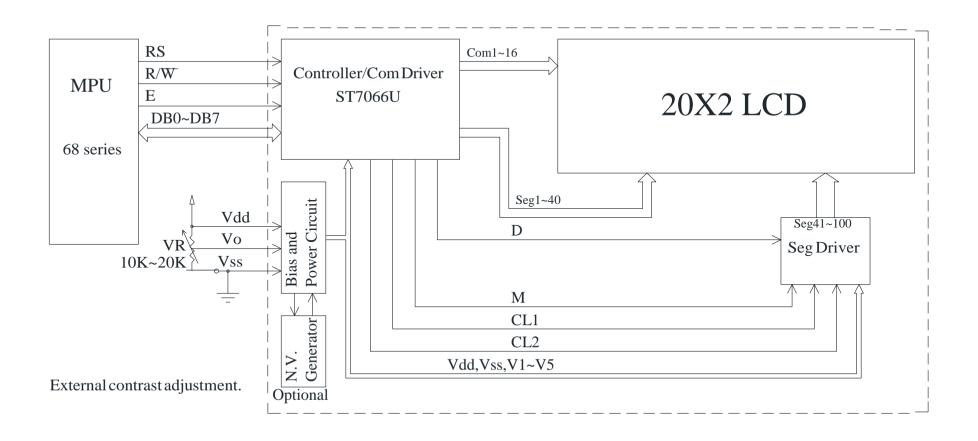


### **6.Interface Pin Function**

Pin No.	Symbol	Level	Description
1	$V_{SS}$	0V	Ground
2	$V_{\mathrm{DD}}$	5.0V	Supply Voltage for logic
3	VO	(Variable)	Contrast Adjustment
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read L: Write
6	Е	Н,Н→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	A	_	Power supply for B/L(+)
16	K	_	Power supply for B/L(-)

#### 7.Contour Drawing & Block Diagram





Character located DDRAM address

DDRAM address

Character located 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20

00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10	11	12	13
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53

### **8.Character Generator ROM Pattern**

Table.2

Upper	T							1								
4 bit	LLLL	LLLH I	LHL L	 LHH LE	 ILL LHI	LH LHH	 IL LHHI	 H HLLL	HLLH I	HLHL H	LHH H	 HLL HF	 ILH HH	 HL HHI	HH	
4 bit																
LLLL	CG RAM (1)			\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	\$ \$5555 \$ \$5555 \$ \$5555 \$	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	*5	5555 5 5				55555	*5* *5	555 555 555		deteletete
LLLH	(2)		के विवेदीय		\$5 55 55 55 55 55 55 55 55 55 55 55 55 5		\$55 5555 5555	55 55 5555 5555			444 444 444	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	מיסיסיסיסיו	\$ \$ \$ \$5	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	CANAMANA
LLHL	(3)		444	5555 5 5	55555 55555 55555 55555	**************************************	5 5555 5 5 5 5	5 55 55 5			10 10 10 10 10 10 10 10 10 10 10 10 10 1	\$ \$ \$ \$ \$ \$	# #### ###############################	**************************************	HAMANA GGGG GGGG GGGG	4444 4 4 4 4 4 4
LLHH	(4)		55 55 55 55 55 55 55 55 55 55	**************************************	**************************************	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	15 15 15 15 15 15 15 15 15 15 15 15 15 1	555 555			PF	****************	555 5555 5	55555 55555	5 555 565 565 565	\$4.4 \$4.4 \$4.4
LHLL	(5)		स् स्वतिक्षेत्रं स्वति स्वतिक्षेत्रं स्वति		4444 4 4 4 4 4 4 4	44444444444444444444444444444444444444	## # # # # # # #	\$4 \$4 \$4 \$4 \$4 \$4 \$4 \$4 \$4 \$4 \$4 \$4 \$4 \$			10 10 10 10 10 10 10 10 10 10 10 10 10 1	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	ಕಡಡಡಿ ಡ ಕ	4444 4 44 4 44 4	HARAY F G WARAY	P 1988 1888 1888 1988
LHLH	(6)		10 10 10 10 10 10 10 10 10 10 10 10 10 1	90 90 90 90 90		19444 19444 19444	5 55 555 555 555	#s #k			**************************************		######################################	4 A4	date about	datas
LHHL	(7)		5 55 5 55 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55 5 5	######################################	4444 4444 444	**************************************	# # # # # # # # # # # # # # # # # # #			55555 55555	4444 4444 4444 4444	<b>1</b> 5	\$555 \$555 \$555 \$5555 \$5555	252	2000 to 1000 t
LHHH	(8)		**************************************		100 100 100 100 100 100 100 100 100 100	#444 # # ##############################	**************************************	*****				**************************************	55555 55555 55555	\$5555 5555 5555 5555	ANAMAN AN	12 12 12 12 12 12 12 12 12 12 12 12 12 1
HLLL	(1)		4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4		444444 44 44 44 44 44 44 44 44 44		444444 44444 44444 44444				2 PAPPE		\$ \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5	4444 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	2000 P	######################################
HLHL	(3)		***************************************	######################################	444	4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	255	5 5 5 5 5 5 5 5 5 5			**************************************	\$ \$5\$ \$5\$ \$5\$ \$5\$ \$5\$ \$5\$ \$5\$ \$5\$ \$5\$ \$5	_		######################################	description of the control of the co
НГНН	(4)		\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		**************************************				\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	50 55 55 55 55 55 55 55 55 55 55 55 55 5	5 5 5 5	ererererererererererererererererererer	
HHLL	(5)		10 10 10 10 10 10 10 10 10 10 10 10 10 1	**************************************	200 00 00 00 00 00 00 00 00 00 00 00 00	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	2	್ ಕ್ರಮಾನ್ಯದ್ದಾರ್			4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	**************************************	**************************************	200 00 00 00 00 00 00 00 00 00 00 00 00	44 P	EARAGE CARACTER CARAC
ннН	(6)		55555 5555	**************************************	444444 4444444444444444444444444444444		00000000000000000000000000000000000000	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$			1001000	**************************************	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$	\$5 \$ \$ \$ \$ \$ \$ \$	CHARRED OF	**************************************
			5 5	5 5 5	\$\$ \$5 \$5 \$5 \$5 \$5 \$5 \$5 \$5	55555	555 5 5 5 5 5 5	5 5 5 5 5			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	\$ \$5 \$ \$5 \$ \$5 \$	55555 5 5 5 5	555 555 555	5 5 5 5 5 5 5 5	chatatatatatata chatatatatata chatatatatata chatatatatata chatatatatata

### 9. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	<b>Environmental Test</b>		
Test Item	Content of Test	Test Condition	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	_
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	_

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

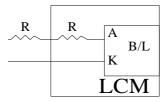
### **10.Backlight Information**

#### **Specification**

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION
Supply Current	ILED	240	300	360	mA	V=5.0V
Supply Voltage	V	4.9	5.0	5.1	V	-
Reverse Voltage	VR	-	-	8	V	-
Luminance (Without LCD)	IV	200	260	-	CD/M <sup>2</sup>	ILED=300mA
Wave Length	λp	569	572	575	nm	ILED=300mA
Life Time	-	-	100000	-	Hr.	ILED≦300mA 25°C,50-60%RH
Color	Yellow Gro	een	•	•	•	

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

#### 2.Drive from pin15,pin16



ill never get Vee output from pin15)

### 11.Inspection specification

NO	Item	Criterion				AQL	
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect.  Missing character, dot or icon.  Display malfunction.  No function or no display.  Current consumption exceeds product specifications.  LCD viewing angle defect.  Mixed product types.  Contrast defect.					
02	Black or white spots on LCD (display only)	three white or	<ul><li>2.1 White and black spots on display ≤0.25mm, no morethan three white or black spots present.</li><li>2.2 Densely spaced: No more than two spots or lines within</li></ul>				
03	LCD black spots, white spots, contaminatio n (non-display)	3.1 Round type $\Phi = (x + y)/2$ $X \longrightarrow X$ 3.2 Line type : (	<u>↓</u> ▼	SIZE	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2	2.5	
			L ≦ 2.5	0.03 < W ≦ 0.05 0.05 < W	As round type		
04	Polarizer bubbles	If bubbles are very judge using bla specifications, to find, must change specify directions.	ck spot not easy <sup>0</sup> neck in	Size $\Phi$ $\Phi \le 0.20$ $.20 < \Phi \le 0.503$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense  2 0 3	2.5	

NO	Item	Criterion						
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination						
		Symbols Define:						
		x: Chip length y: 0	Chip width z: Chip	thickness				
		k: Seal width t: 0	Glass thickness a: LCI	O side length				
		L: Electrode pad length:						
		6.1 General glass chip:						
		6.1.1 Chip on panel surf	ace and crack between	panels:				
			N A A A A A A A A A A A A A A A A A A A					
		z: Chip thickness	y: Chip width	x: Chip length				
		Z≦1/2t	Not over viewing	x≦1/8a				
06	Chipped		area		2.5			
	glass	1/2t < z ≦ 2t	Not exceed 1/3k	x≦1/8a				
		⊙ If there are 2 or more chips, x is total length of each chip.						
		6.1.2 Corner crack:	<b>文</b> y					
		z: Chip thickness	y: Chip width	x: Chip length				
		Z≦1/2t	Not over viewing	x≦1/8a				
			area					
		1/2t < z≦2t	Not exceed 1/3k	x≦1/8a				
		l olf there are 2 or more	e chips, x is the total ler	gth of each chip.				
	<u> </u>	<u> </u>						

NO	Item	Criterion			AQL
		x: Chip length y: Chip wide k: Seal width t: Glass thin L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	•	nickness ide length	
06	Glass crack	y: Chip width $x$ : Chip $y \le 0.5$ mm $x \le 1/8$ 6.2.2 Non-conductive portion:		$\frac{1}{2} \le \frac{1}{2}$	2.5
			ling to electrode taled by the custor	erminal specifications.	

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul><li>8.1 Illumination source flickers when lit.</li><li>8.2 Spots or scratched that appear when lit must be judged.</li><li>Using LCD spot, lines and contamination standards.</li><li>8.3 Backlight doesn't light or color wrong.</li></ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB · COB	10.1 COB seal may not have pinholes larger than 0.2mmor contamination.  10.2 COB seal surface may not have pinholes through to theIC.  10.3 The height of the COB should not exceed the height indicated in the assembly diagram.  10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.  10.5 No oxidation or contamination PCB terminals.  10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.  10.7 The jumper on the PCB should conform to the product characteristic chart.  10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.  10.9 The Scraping testing standard for Copper Coating of PCB	<ul> <li>2.5</li> <li>2.5</li> <li>0.65</li> <li>2.5</li> <li>0.65</li> <li>0.65</li> <li>2.5</li> <li>2.5</li> </ul>
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solderconnections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends oninterface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls onproduct.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to	
		sever.	2.5
	General	12.6 The residual rosin or tin oil of soldering (component orchip	
12		component) is not burned into brown or black color.	2.5
	appearance	12.7 Sealant on top of the ITO circuit has nothardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	
		specification sheet.	0.65
		12.11 Product dimension and structure must conform to product	
		specification sheet.	0.65
		12.12 Visual defect outside of VA is not considered to be	
		rejection.	

## **12.Material List of Components for RoHs**

1. AGT Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs			
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm			
Above limit	Ahove limited value is set up according to RoHS								

- 2. Process for RoHS requirement: (only for RoHS inspection)
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we usedbefore.
  - (2)Heat-resistance temp.:

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering ∶ 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°€;

Recommended customer's soldering temp. of connector  $: 280^{\circ}$ C, 3 seconds.

### 14.Recommendable Storage

<ol> <li>Place</li> </ol>	the panel or mo	odule in the temperat	ture 25°C±5°C and	the humidit	y below 65% RH
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- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

#### **LCM Sample Estimate Feedback Sheet**

Iodu	ııe	Number:				Page: 1
1、	. <u>Р</u> а	anel Specification:				
-	1.	Panel Type:		Pass	NG ,	
2	2.	View Direction:		Pass	NG ,	
3	3.	Numbers of Dots:		Pass	NG ,	
4	4.	View Area:		Pass	NG ,	
į	5.	Active Area:		Pass	NG ,	
(	6.	Operating Temperature:		Pass	NG ,	
7	7.	Storage Temperature:		Pass	NG ,	
8	8.	Others:				
2、	<u> </u>	lechanical Specification:				
2	1.	PCB Size:		Pass	NG ,	
2	2.	Frame Size:		Pass	NG ,	
3	3.	Materal of Frame:		Pass	NG ,	
4	4.	Connector Position:		Pass	NG ,	
į	5.	Fix Hole Position:		Pass	NG ,	
6	6.	Backlight Position:		Pass	NG ,	
7	7.	Thickness of PCB:		Pass	NG ,	
8	8.	Height of Frame to PCB:		Pass	NG ,	
g	9.	Height of Module:		Pass	NG ,	
2	10.	Others:		Pass	NG ,	
3、	. <u>R</u>	elative Hole Size:				
2	1.	Pitch of Connector:		Pass	NG ,	
2	2.	Hole size of Connector:		Pass	NG ,	
3	3.	Mounting Hole size:		Pass	NG ,	
4	4.	Mounting Hole Type:		Pass	NG ,	
į	5.	Others:		Pass	NG ,	
4、	Ba	acklight Specification:				
2	1.	B/L Type:		Pass	NG ,	
2	2.	B/L Color:		Pass	NG ,	
3	3.	B/L Driving Voltage (Reference	ce fo	r LEDType):	Pass	☐ NG , <u></u>
4	4.	B/L Driving Current:		Pass	NG ,	
Ţ	5.	Brightness of B/L:		Pass	NG ,	
(	6. <sup> </sup>	B/L Solder Method:		Pass	NG ,	
-	7. (	Others:		Pass	NG ,	

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Module Number:		ı	Page: 2
5 · Electronic Characteristics of N	<u> Module</u> :		
1. Input Voltage:	Pass	☐ NG	
2. Supply Current:	Pass	☐ NG	
<ol><li>Driving Voltage for LCD :</li></ol>	Pass	☐ NG	
4. Contrast for LCD:	Pass	☐ NG	
<ol><li>B/L Driving Method :</li></ol>	Pass	☐ NG	
6. Negative Voltage Output :	Pass	☐ NG	
7. Interface Function:	Pass	☐ NG	
8. LCD Uniformity:	Pass	☐ NG	
9. ESD test:	Pass	☐ NG	
10. Others:	Pass	☐ NG	
6 · <u>Summary</u> :			
Sales signature:			
Customer Signature:		Date: /	